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a tape attached to the substrate comprising a polymer film and a conductor on the polymer film with an opening proximate to the depression; and

a conductive material on the substrate electrically connecting the conductive layer and the conductor.

75. A system for testing semiconductor dice contained on a wafer, comprising:

a wafer probe handler in electrical communication with testing circuitry;

a probe card mounted to the wafer probe handler comprising a substrate and a plurality of contact members configured to electrically connect to contact locations on the dice; and

a tape comprising a polymer film and a plurality of conductors in electrical communication with the contact members, the tape configured to physically attach the probe card to the wafer probe handler with the contact members in electrical communication with the testing circuitry.

76. The system of claim 75 further comprising a conductive adhesive for electrically connecting the contact members to the conductors.

77. The system of claim 75 further comprising a solder for electrically connecting the contact members to the conductors.

#### REMARKS


This divisional application is being filed due to the restriction requirement contained in the Office Action dated March 29, 1999, in parent case serial no. 08/821,468.

Also being submitted with this divisional application is an Information Disclosure Statement. Favorable consideration and allowance of amended claims 34-51 and added claims 68-77 is respectfully requested. Should any issues arise that will

advance this case to allowance, the Examiner is asked to contact the undersigned by telephone.

DATED this 30th day of April, 1999.

Respectfully submitted:

  
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April 30, 1999  
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Stephen A. Gratton, Attorney for Applicants